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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

COMPLEMENTARY N-CHANNEL AND P-CHANNEL MOSFET

GENERAL DESCRIPTION

The ALD1115 is a monolithic complementary N-channel and P-channel transistor pair intended for a broad range of analog applications. These enhancement-mode transistors are manufactured with Advanced Linear Devices' enhanced ACMOS silicon gate CMOS process. It consists of a N-channel MOSFET and a P-channel MOSFET in one package. The ALD1115 is a dual version of the quad complementary ALD1105.

The ALD1115 offers high input impedance and negative current temperature coefficient. The transistor pair is designed for precision signal switching and amplifying applications in +1V to +12V systems where low input bias current, low input capacitance and fast switching speed are desired. Since these are MOSFET devices, they feature very large (almost infinite) current gain in a low frequency, or near DC, operating environment. When connected in parallel with sources, drains and gates connected together, a CMOS analog switch can be constructed. In addition, the ALD1115 is intended as a building block for CMOS inverters, differential amplifier input stages, transmission gates, and multiplexer applications.

The ALD1115 is suitable for use in precision applications which require very high current gain, beta, such as current mirrors and current sources. The high input impedance and the high DC current gain of the field effect transistors result in extremely low current loss through the control gate. The DC current gain is limited by the gate input leakage current, which is specified at 30pA at room temperature. V+ is connected to the substrate, which is the most positive voltage potential of the ALD1115, usually SP (5). Similarly, V- is connected to the most negative voltage potential of the ALD1115, usually SN (1).

FEATURES

- Thermal tracking between N-channel and P-channel
- Low threshold voltage of 0.7V for both N-channel and P-channel MOSFETs
- Low input capacitance
- High input impedance -- $10^{13}\Omega$ typical
- Low input and output leakage currents
- Negative current (I_{DS}) temperature coefficient
- Enhancement mode (normally off)
- DC current gain 10^9
- Single N-channel MOSFET and single P-channel MOSFET in one package

ORDERING INFORMATION ("L"suffix for lead free version)

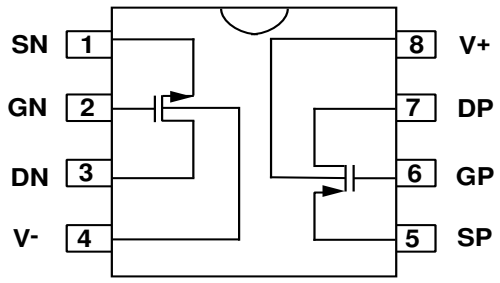
Operating Temperature Range*	
0°C to +70°C	0°C to +70°C
8-Pin SOIC Package	8-Pin Plastic Dip Package
ALD1115SAL	ALD1115PAL

* Contact factory for leaded (non-RoHS) or high temperature versions.

APPLICATIONS

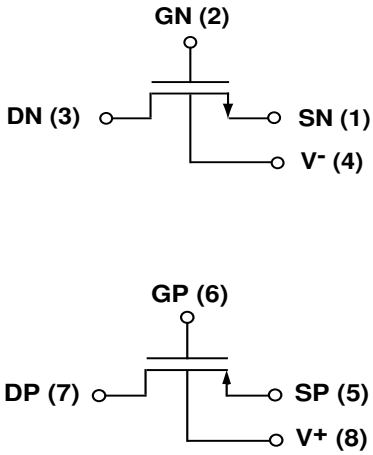
- Precision current mirrors
- Complementary push-pull linear drives
- Discrete analog switches
- Analog signal choppers
- Differential amplifier input stage
- Voltage comparator
- Data converters
- Sample and Hold
- Analog current inverter
- Precision matched current sources
- CMOS inverter stage
- Diode clamps
- Source followers

PIN CONFIGURATION



TOP VIEW
SAL, PAL PACKAGES

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

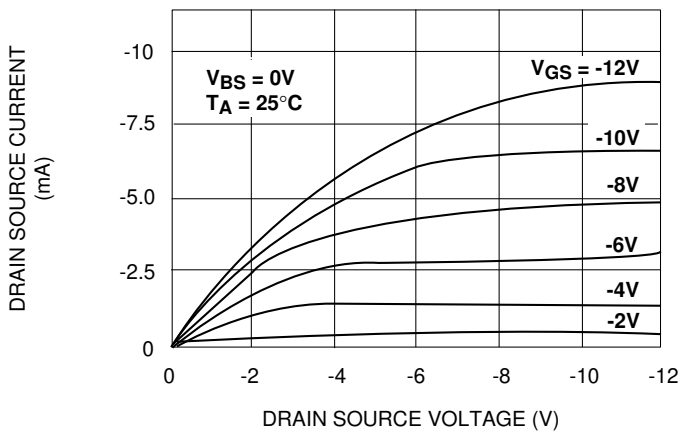
Drain-source voltage, V_{DS} ____ 10.6V
Gate-source voltage, V_{GS} ____ 10.6V
Power dissipation ____ 500 mW
Operating temperature range SAL, PALpackages ____ 0°C to +70°C
Storage temperature range ____ -65°C to +150°C
Lead temperature, 10 seconds ____ +260°C
CAUTION: ESD Sensitive Device. Use static control procedures in ESD controlled environment.

OPERATING ELECTRICAL CHARACTERISTICS
T_A = 25°C unless otherwise specified

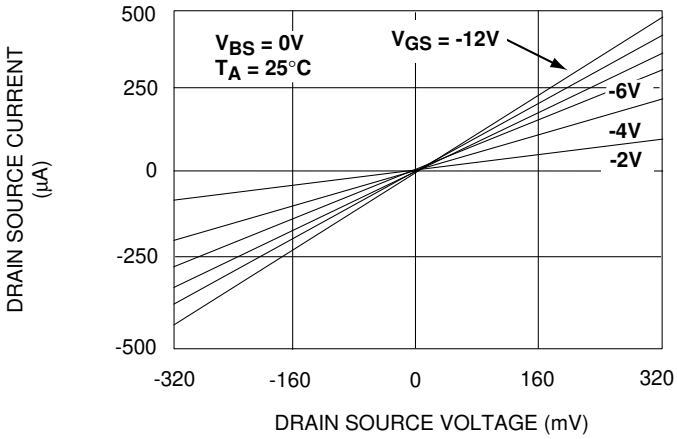
		N - Channel				Test	P - Channel				Test
Parameter	**Symbol**	**Min**	**Typ**	**Max**	**Unit**	**Conditions**	**Min**	**Typ**	**Max**	**Unit**	**Conditions**
Gate Threshold Voltage	V_T	0.4	0.7	1.0	V	I_{DS} = 1μA V_{GS} = V_{DS}	-0.4	-0.7	-1.0	V	I_{DS} = -1μA V_{GS} = V_{DS}
Gate Threshold Temperature Drift	TC_{VT}		-1.2		mV/°C			-1.3		mV/°C	
On Drain Current	$I_{DS\ (ON)}$	3	4.8		mA	V_{GS} = V_{DS} = 5V	-1.3	-2		mA	V_{GS} = V_{DS} = -5V
Trans-. conductance	G_{fs}	1	1.8		mmho	V_{DS} = 5V I_{DS}= 10mA	0.25	0.67		mmho	V_{DS} = -5V I_{DS}= -10mA
Output Conductance	G_{OS}		200		μmho	V_{DS} = 5V I_{DS} = 10mA		40		μmho	V_{DS} = -5V I_{DS} = -10mA
Drain Source ON Resistance	$R_{DS(ON)}$		350	500	Ω	V_{DS} = 0.1V V_{GS} = 5V		1200	1800	Ω	V_{DS} = -0.1V V_{GS} = -5V
Drain Source Breakdown Voltage	BV_{DSS}	10			V	I_{DS} = 1μA V_{GS} =0V	-10			V	I_{DS} = -1μA V_{GS} =0V
Off Drain Current	$I_{DS(OFF)}$		10	400 4	pA nA	V_{DS} =10V I_{GS} = 0V T_A = 125°C		10	400 4	pA nA	V_{DS} = -10V V_{GS} = 0V T_A = 125°C
Gate Leakage Current	I_{GSS}		0.1	30 1	pA nA	V_{DS} = 0V V_{GS} =10V T_A = 125°C		1	30 1	pA nA	V_{DS} = 0V V_{GS} =-10V T_A = 125°C
Input Capacitance	C_{ISS}		1	3	pF			1	3	pF	

TYPICAL P-CHANNEL PERFORMANCE CHARACTERISTICS

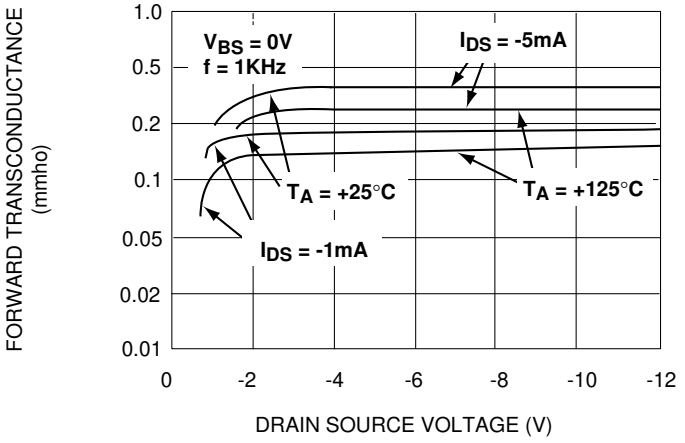
OUTPUT CHARACTERISTICS



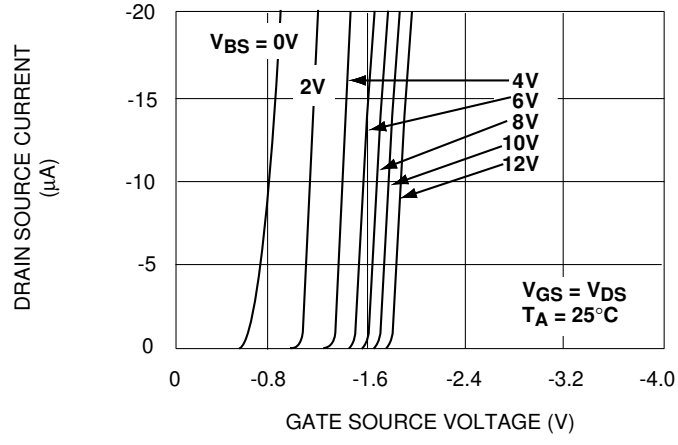
LOW VOLTAGE OUTPUT CHARACTERISTICS



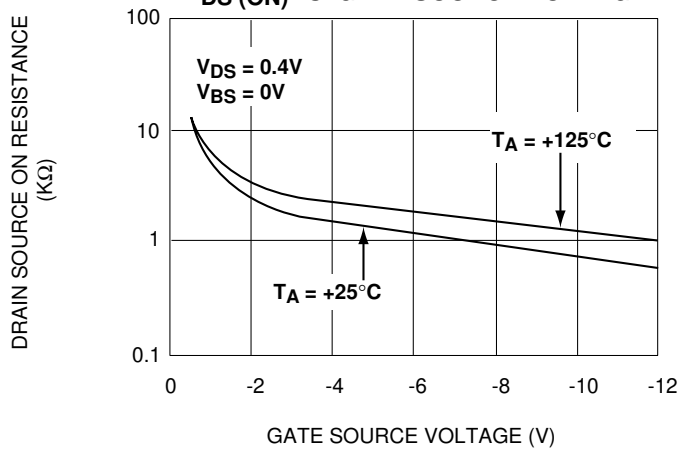
FORWARD TRANSCONDUCTANCE vs. DRAIN SOURCE VOLTAGE



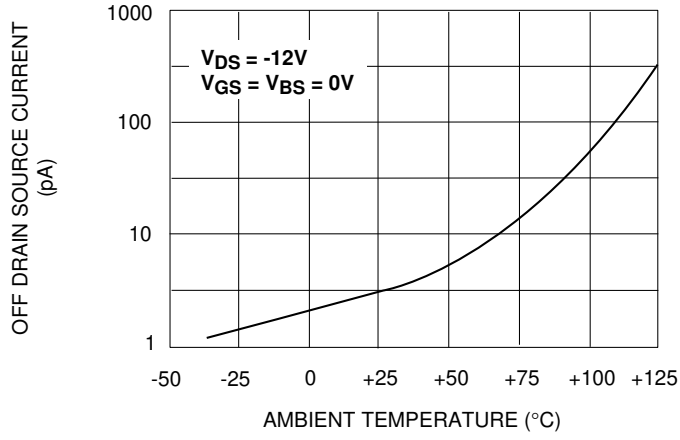
TRANSFER CHARACTERISTIC WITH SUBSTRATE BIAS



DRAIN SOURCE ON RESISTANCE $R_{DS\ (ON)}$ vs. GATE SOURCE VOLTAGE

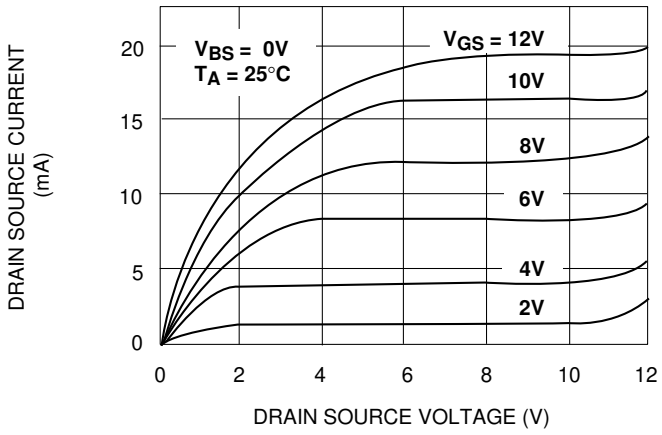


OFF DRAIN CURRENT vs. AMBIENT TEMPERATURE

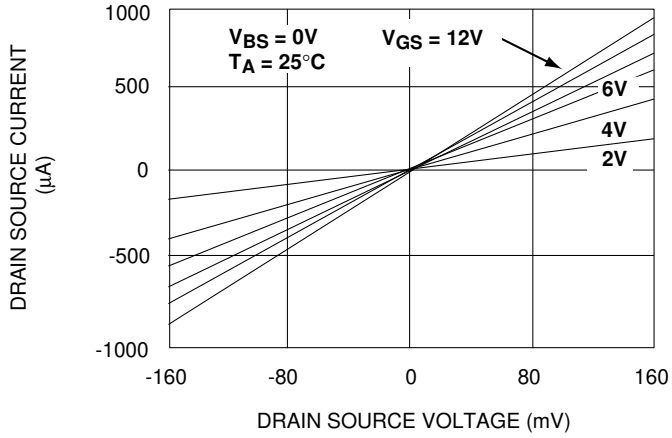


TYPICAL N-CHANNEL PERFORMANCE CHARACTERISTICS

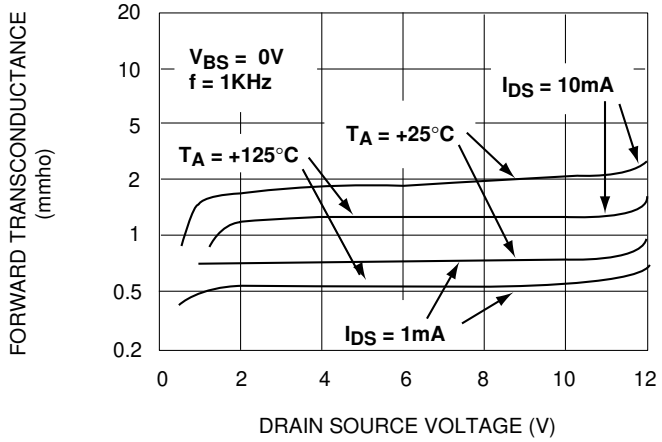
OUTPUT CHARACTERISTICS



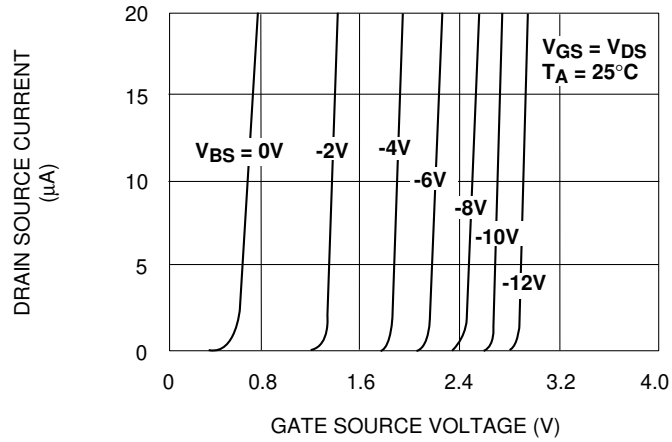
LOW VOLTAGE OUTPUT CHARACTERISTICS



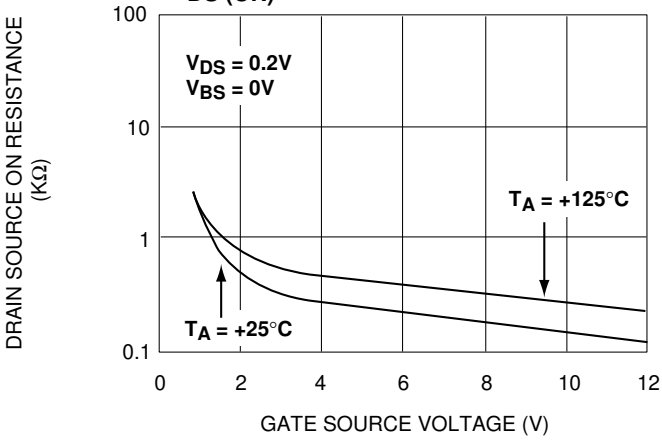
FORWARD TRANSCONDUCTANCE vs. DRAIN SOURCE VOLTAGE



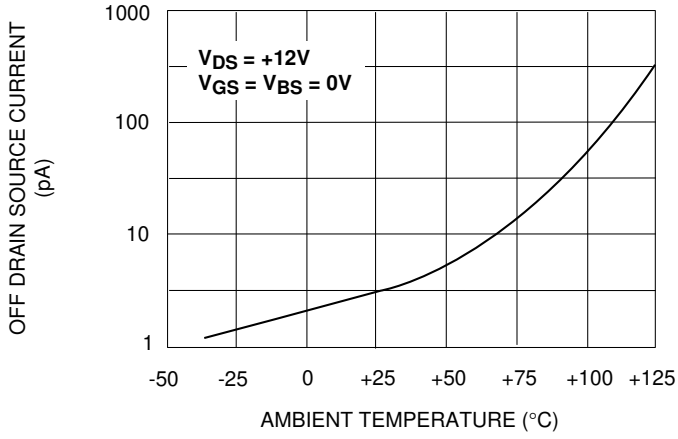
TRANSFER CHARACTERISTIC WITH SUBSTRATE BIAS



DRAIN SOURCE ON RESISTANCE $R_{DS\ (ON)}$ vs. GATE SOURCE VOLTAGE

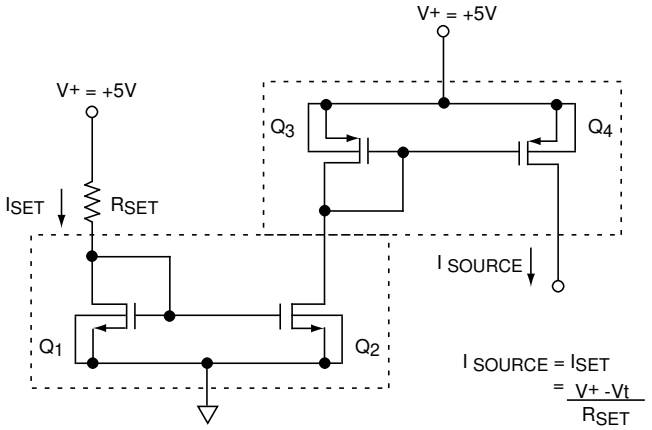


OFF DRAIN CURRENT vs. AMBIENT TEMPERATURE



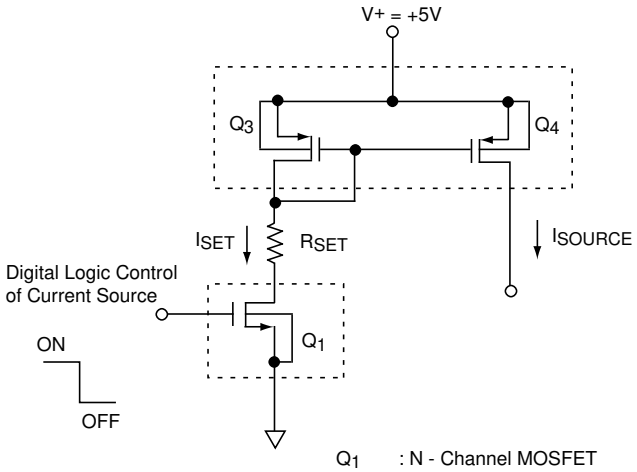
TYPICAL APPLICATIONS

CURRENT SOURCE MIRROR



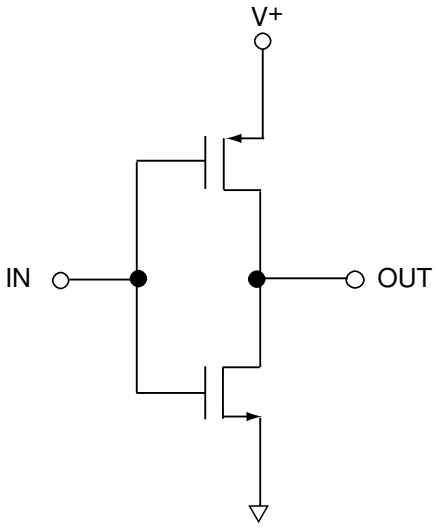
Q_1, Q_2: N - Channel MOSFET
Q_3, Q_4: P - Channel MOSFET

CURRENT SOURCE WITH GATE CONTROL

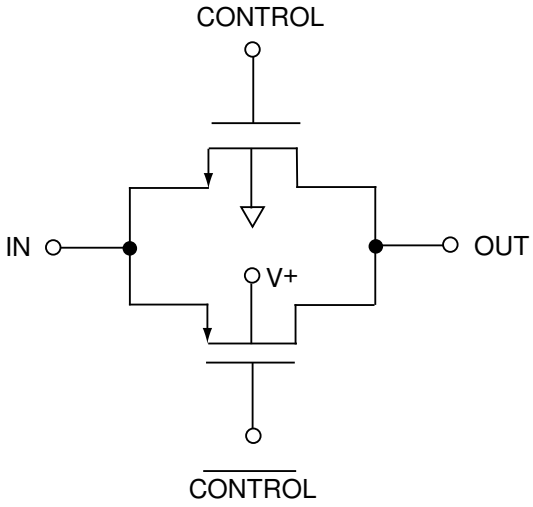


Q_1 : N - Channel MOSFET
$Q_{3,}Q_4$: P - Channel MOSFET

CMOS INVERTER

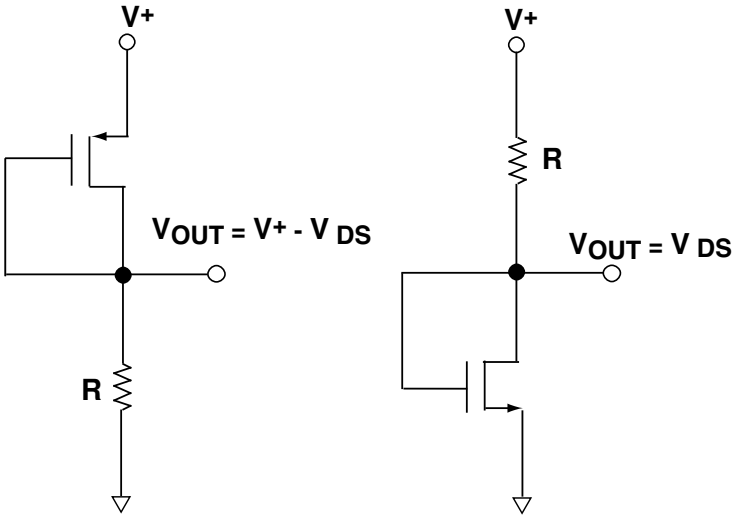


CMOS ANALOG SWITCH

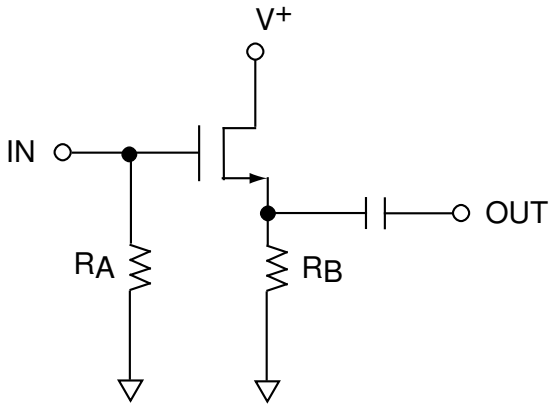


TYPICAL APPLICATIONS (cont.)

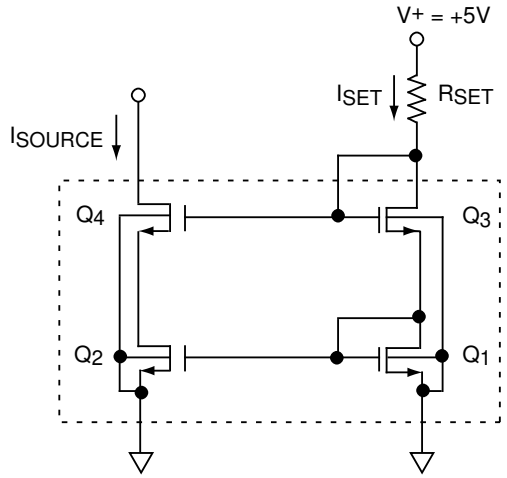
DIODE-CONNECTED CONFIGURATION



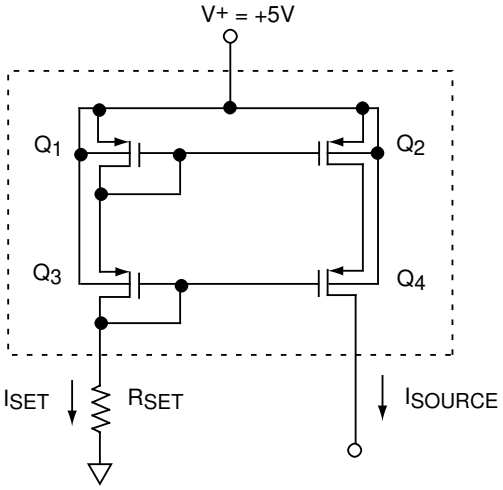
SOURCE FOLLOWER



CASCODE CURRENT SOURCES



Q_1, Q_2, Q_3, Q_4: N - Channel MOSFET

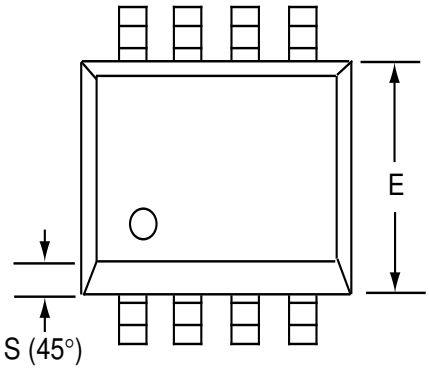


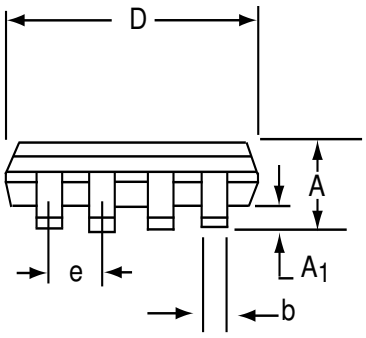
$$I_{SOURCE} = I_{SET} = \frac{V+ - 2Vt}{R_{SET}} \cong \frac{3}{R_{SET}}$$

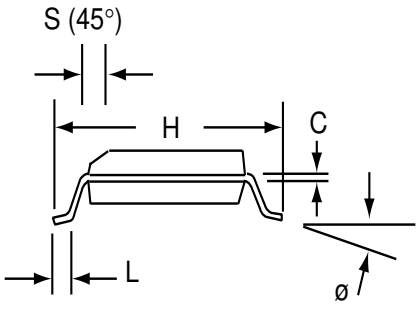
Q1, Q2, Q3, Q4: P - Channel MOSFET

SOIC-8 PACKAGE DRAWING

8 Pin Plastic SOIC Package



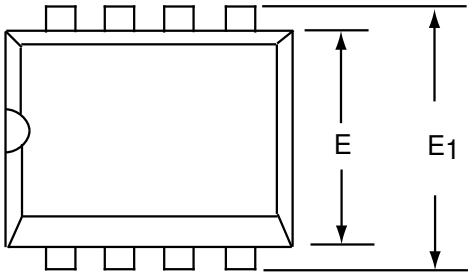


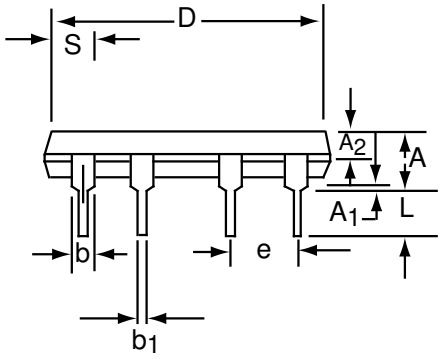


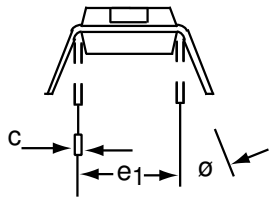
Dim	Millimeters		Inches	
	Min	Max	Min	Max
A	1.35	1.75	0.053	0.069
A_1	0.10	0.25	0.004	0.010
b	0.35	0.45	0.014	0.018
C	0.18	0.25	0.007	0.010
D-8	4.69	5.00	0.185	0.196
E	3.50	4.05	0.140	0.160
e	1.27 BSC		0.050 BSC	
H	5.70	6.30	0.224	0.248
L	0.60	0.937	0.024	0.037
Ø	0°	8°	0°	8°
S	0.25	0.50	0.010	0.020

PDIP-8 PACKAGE DRAWING

8 Pin Plastic DIP Package







Dim	Millimeters		Inches	
	Min	Max	Min	Max
A	3.81	5.08	0.105	0.200
A_1	0.38	1.27	0.015	0.050
A_2	1.27	2.03	0.050	0.080
b	0.89	1.65	0.035	0.065
b_1	0.38	0.51	0.015	0.020
c	0.20	0.30	0.008	0.012
D-8	9.40	11.68	0.370	0.460
E	5.59	7.11	0.220	0.280
E_1	7.62	8.26	0.300	0.325
e	2.29	2.79	0.090	0.110
e_1	7.37	7.87	0.290	0.310
L	2.79	3.81	0.110	0.150
S-8	1.02	2.03	0.040	0.080
ø	0°	15°	0°	15°